

PA3202

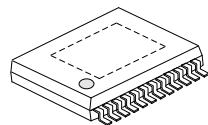
CMOS IC

2-W STEREO AUDIO POWER AMPLIFIER WITH MUTE

■ DESCRIPTION

The UTC **PA3202** is a monolithic integrated circuit that stereo bridged audio power amplifiers capable of producing 2 W into 3Ω with a 5V supply voltage or 800mW into 3Ω with a 3.3V supply voltage .The UTC **PA3202** simplifies design and frees up board space for other features. Both of the depop circuitry and the thermal shutdown protection circuitry are integrated in UTC **PA3202**, that reduce clicks and pops noise during power up or shutdown mode operation.

A MUX control terminal (HP/LINE) allows selection between the two sets of stereo input signals. To simplify the audio system design, UTC **PA3202** combines a stereo bridge-tied loads (BTL) mode for speaker drive and a stereo single-end (SE) mode for headphone drive into a single chip, where both modes are easily switched by the SE/BTL input control pin signal.



HTSSOP-24

■ FEATURES

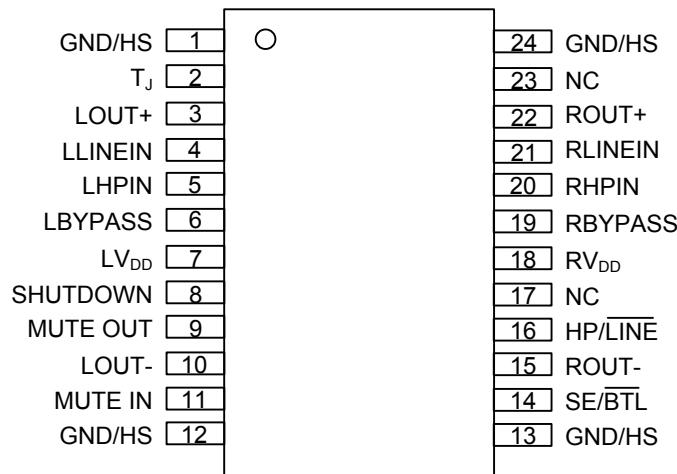
- * Improves depop circuitry to eliminate turn-on and turn-off transients in output
- * Output power:
-2W(typ.)@5V into 3Ω with 0.2% THD+N max (1kHz)
-800mW(typ.)@3.3V into 3Ω with 0.2% THD+N max (1kHz)
- * Fully specified for use with 3-Ω Loads
- * Stereo switchable bridged/single-ended power amplifiers
- * Input MUX select terminal
- * Thermal-shutdown protection
- * Shutdown mode available

■ ORDERING INFORMATION

Ordering Number		Package	Packing
Lead Free	Halogen Free		
PA3202L-N24-R	PA3202G-N24-R	HTSSOP-24	Tape Reel
PA3202L-N24-T	PA3202G-N24-T	HTSSOP-24	Tube

 PA3202L-N24-R	(1)Packing Type (2)Package Type (3)Lead Plating	(1) R: Tape Reel, T: Tube (2) N24: HTSSOP-24 (3) G:Halogen Free, L: Lead Free
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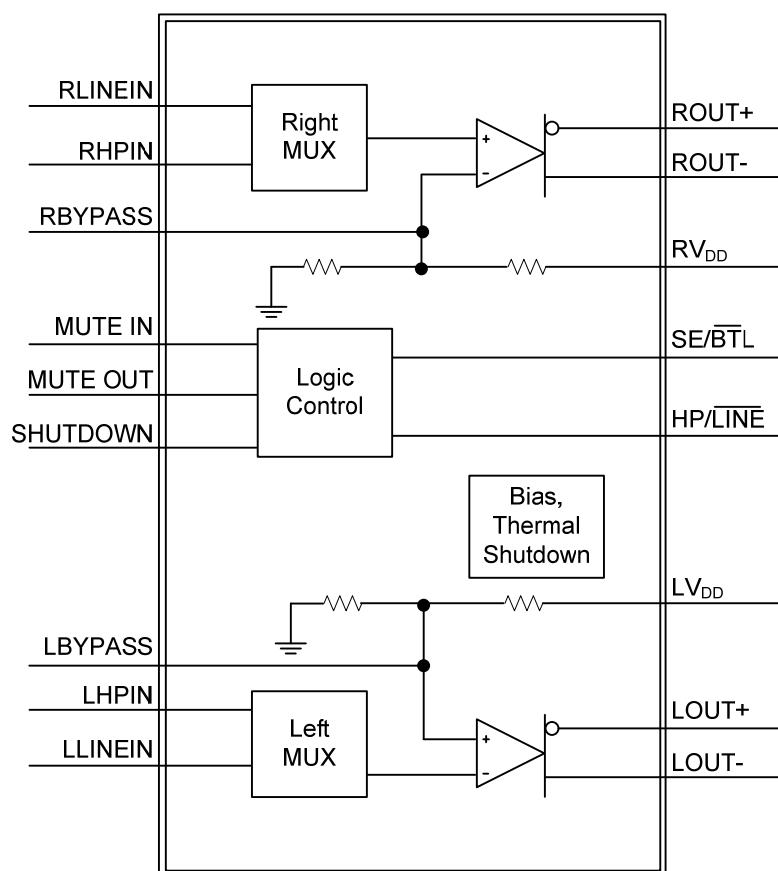
■ PIN CONFIGURATION



■ PIN DESCRIPTION

PIN NO	PIN NAME	I/O	DESCRIPTION
1, 12, 13, 24	GND/HS		Power ground; directly connected to thermal pad.
6	LBYPASS		Tap to left channel internal mid-supply voltage divider bias
17, 23	NC		No connection
19	RBYPASS		Tap to right channel internal mid-supply voltage divider bias
4	LLINE IN	I	Left channel line input; selected when HP/LINE is held low
5	LHP IN	I	Left channel headphone input; selected when HP/LINE is held high
7	LV _{DD}	I	Left channel power supply and for primary bias circuits
8	SHUTDOWN	I	Places entire IC in shutdown mode when held high, I _{DD} = 5µA
9	MUTE OUT	I	Follows MUTE IN, provides buffered output
11	MUTE IN	I	Mute all amplifiers input; high active to mute amplify, low active to normal operation
14	SE/BTL	I	SE & BTL mode selection; active high for SE mode, active low for BTL mode
16	HP/LINE	I	MUX control input, active high to select headphone input, active low to select line input
18	RV _{DD}	I	Right channel power supply
20	RHPIN	I	Right channel headphone input, selected when HP/LINE is held high
21	RLINEIN	I	Right channel line input, selected when HP/LINE is held low
2	T _J	O	Sources current proportional to the junction temperature. Left floating for normal operation.
3	LOUT+	O	Left channel + output in BTL & SE mode
10	LOUT-	O	Left channel – output in BTL mode & high-impedance in SE mode
22	ROUT+	O	Right channel + output in BTL & SE mode
15	ROUT-	O	Right channel – output in BTL mode & high impedance in SE mode

■ BLOCK DIAGRAM



■ ABSOLUTE MAXIMUM RATINGS (unless otherwise specified)

PARAMETER	SYMBOL	RATINGS	UNIT
Supply Voltage	V _{DD}	6	V
Input Voltage	V _{IN}	-0.3~V _{DD} ~+0.3	V
Continuous Total Power Dissipation	P _D	Internally limited	
Junction Temperature	T _J	+150	°C
Operating Temperature	T _{OPR}	-40 ~ +85	°C
Storage Temperature	T _{STG}	-65 ~ +150	°C

Note: Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

■ RECOMMENDED OPERATING CONDITIONS

PARAMETER	SYMBOL		MIN	NOM	MAX	UNIT
Supply Voltage	V _{DD}		3	5	5.5	V
Operating Temperature	T _{OPR}	V _{DD} = 5 V, 250 mW/ch average power, with proper PCB design	4-Ω stereo BTL drive, with proper PCB design	-40		85
		V _{DD} = 5 V, 2 W/ch average power,	3-Ω stereo BTL drive, with proper PCB design	-40		85
Common Mode Input Voltage	V _{ICM}	V _{DD} =5V V _{DD} =3.3V		1.25		4.5
				1.25		2.7

■ DC ELECTRICAL CHARACTERISTICS (T_A = 25°C)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP(1)	MAX	UNIT
Supply Current	I _{DD}	V _{DD} =5V	Stereo BTL	19	30	mA
			Stereo SE	9	18	
			Mono BTL	9	18	
			Mono SE	3	10	
		V _{DD} =3.3V	Stereo BTL	13	20	mA
			Stereo SE	5	10	
			Mono BTL	5	10	
			Mono SE	3	6	
Output Offset Voltage (Measured Differentially)	V _{O(OFF)}	V _{DD} = 5 V, Gain = 2, See Note 1		5	25	mV
Supply Current in Mute Mode	I _{DD(MUTE)}	V _{DD} =5V		1		mA
I _{DD} in Shutdown	I _{DD(SD)}	V _{DD} =5V		5	19	μA

Note 1. At 3 V < V_{DD} < 5 V the dc output voltage is approximately V_{DD}².

■ AC OPERATING CHARACTERISTICS

 $V_{DD} = 5 \text{ V}$, $T_A = 25^\circ\text{C}$, $R_L = 3\Omega$

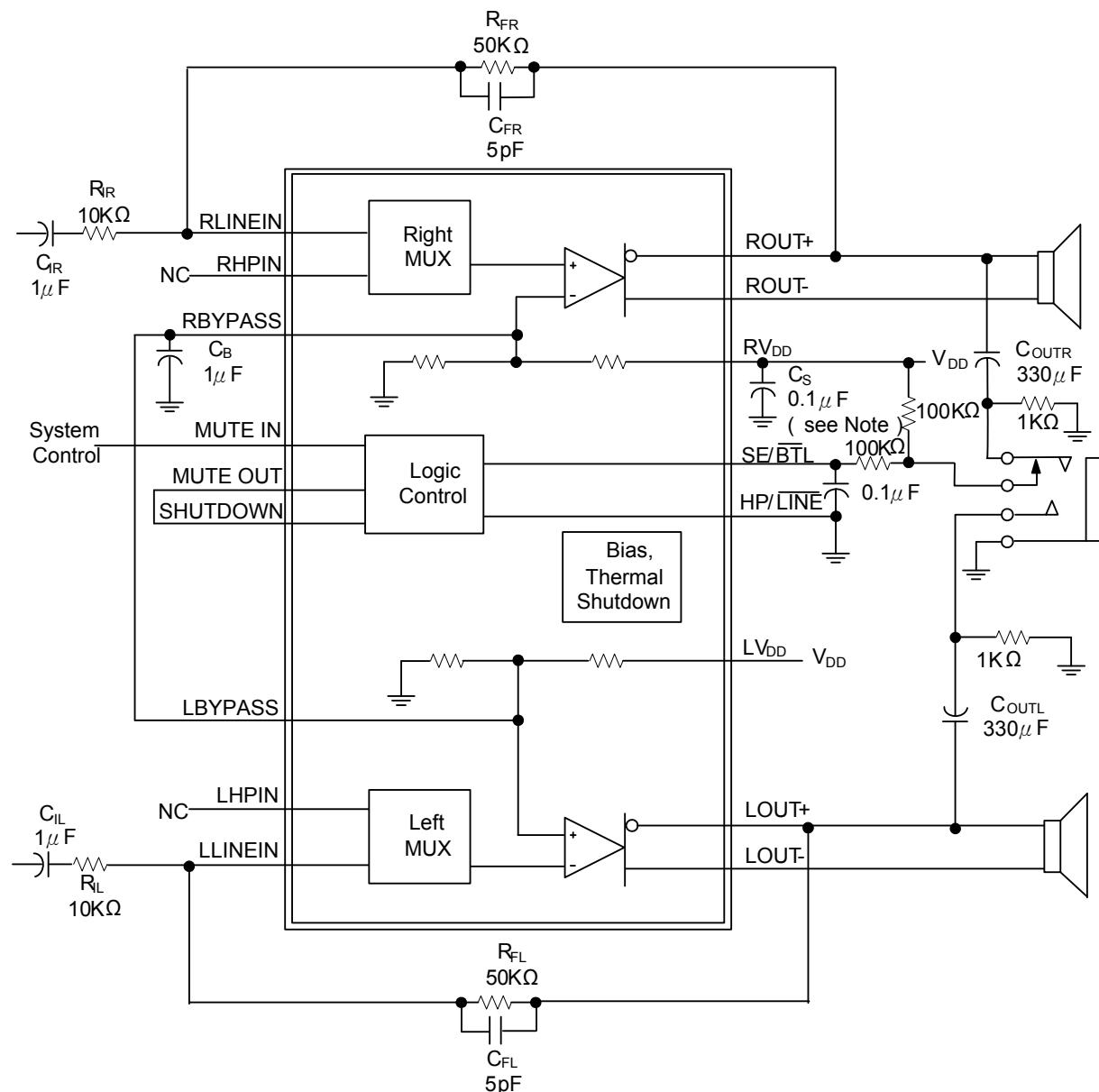
PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Output Power (Each Channel) See Note 2	P_{OUT}	THD =0.2% BTL		2		W
		THD =1% BTL		2.2		
Total Harmonic Distortion Plus Noise	TDH+N	$P_{OUT} = 2 \text{ W}$, $f = 20 \sim 20 \text{ kHz}$	200			m%
		$V_{IN} = 1\text{V}$, $R_L = 10\text{K}\Omega$, $A_V = 1\text{V/V}$	100			
Maximum Output Power Bandwidth	B_W	$A_V = 10 \text{ V/V}$, THD < 1 %,	>20			KHz
Phase Margin		$R_L = 4 \Omega$, Open Loop,	85°			
Supply Ripple Rejection Ratio	RR	$f = 1 \text{ kHz}$		80		dB
		$f = 20 \sim 20 \text{ kHz}$,		60		
Mute Attenuation			85			dB
Channel-to-Channel Output Separation		$f = 1 \text{ kHz}$	85			dB
Line/HP Input Separation			100			dB
BTL Attenuation in SE Mode			100			dB
Input Impedance	Z_{IN}		2			$\text{M}\Omega$
Signal-to-Noise Ratio		$P_{OUT} = 500\text{mW}$, BTL	95			dB
Output Noise Voltage	eN		21			$\mu\text{V}_{(\text{RMS})}$

 $V_{DD} = 3.3 \text{ V}$, $T_A = 25^\circ\text{C}$, $R_L = 3\Omega$

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Output Power (Each Channel) See Note 2	P_{OUT}	THD =0.2% BTL		800		mW
		THD =1% BTL		900		
Total Harmonic Distortion Plus Noise	TDH+N	$P_{OUT} = 800\text{mW}$, $f = 20 \sim 20 \text{ kHz}$	350			m%
		$V_{IN} = 1\text{V}$, $R_L = 10\text{K}\Omega$, $A_V = 1\text{V/V}$	200			
Maximum Output Power Bandwidth	B_W	$A_V = 10 \text{ V/V}$, THD < 1 %,	>20			KHz
Phase Margin		$R_L = 4 \Omega$, Open Loop	85°			
Supply Ripple Rejection Ratio	RR	$f = 1 \text{ kHz}$		70		dB
		$f = 20 \sim 20 \text{ kHz}$,		55		
Mute Attenuation			85			dB
Channel-to-Channel Output Separation		$f = 1 \text{ kHz}$	85			dB
Line/HP Input Separation			100			dB
BTL Attenuation in SE Mode			100			dB
Input Impedance	Z_{IN}		2			$\text{M}\Omega$
Signal-to-Noise Ratio		$P_{OUT} = 500\text{mW}$, BTL	95			dB
Output Noise Voltage	eN		21			$\mu\text{V}_{(\text{RMS})}$

Note 2. Output power is measured at the output terminals of the IC at 1 kHz.

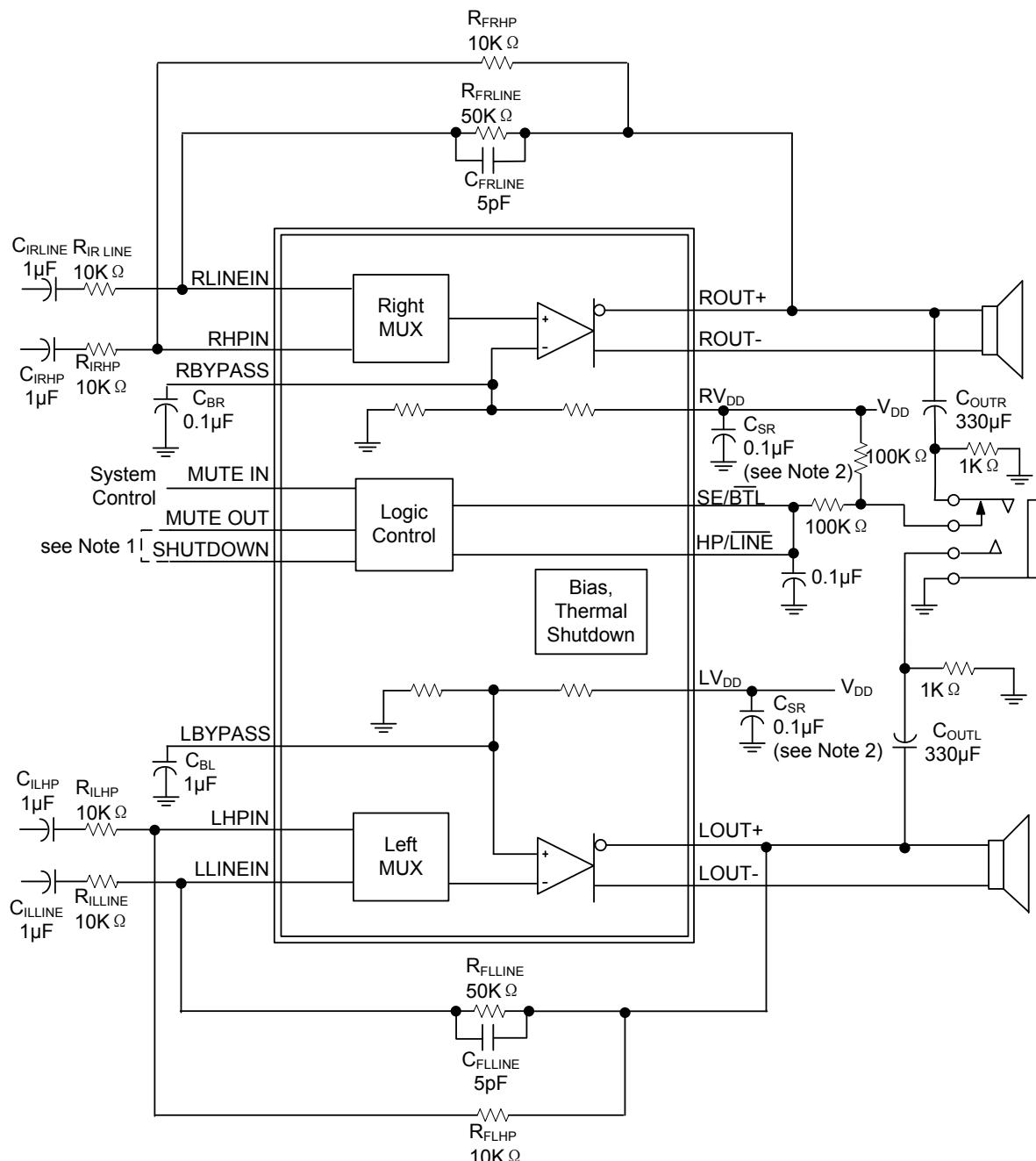
■ TYPICAL APPLICATION CIRCUIT



Note: 0.1 μ F ceramic capacitor should be placed as close as possible to the IC. For filtering lower frequency noise signals, a larger aluminum electrolytic capacitor of 10 μ F or greater should be placed near the audio power amplifier.

PA3202 Minimum Configuration Application Circuit

■ TYPICAL APPLICATION CIRCUIT

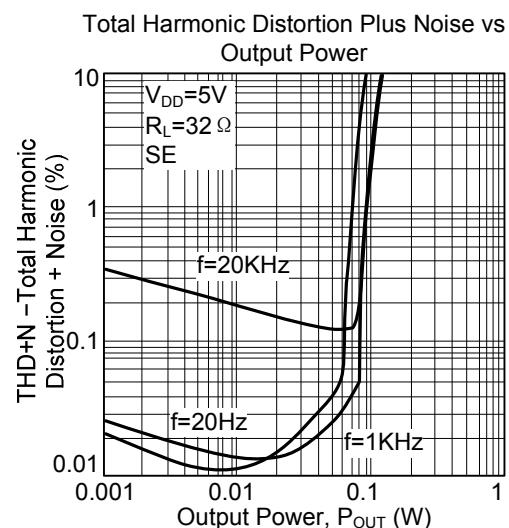
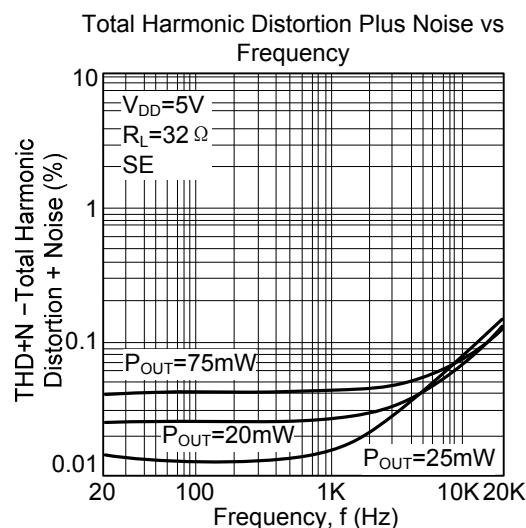
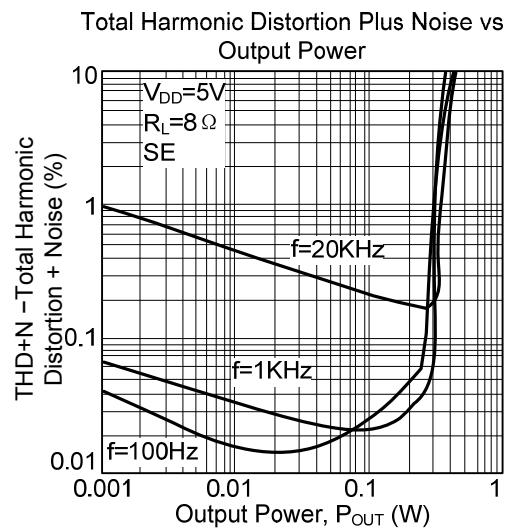
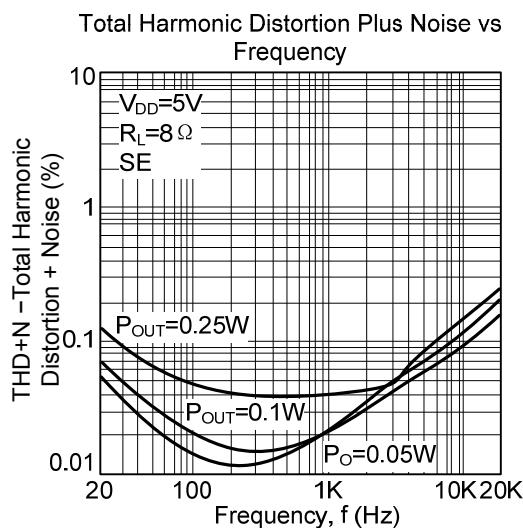
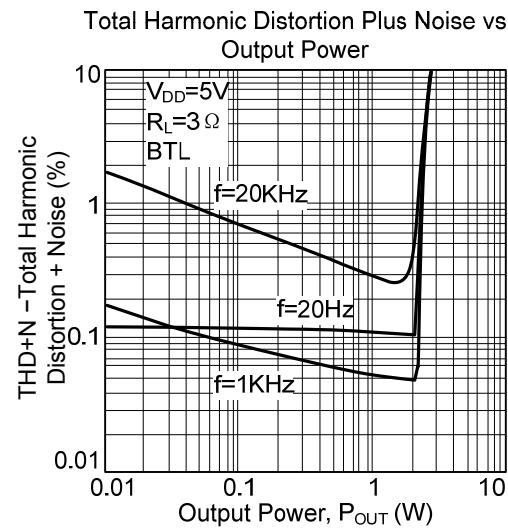
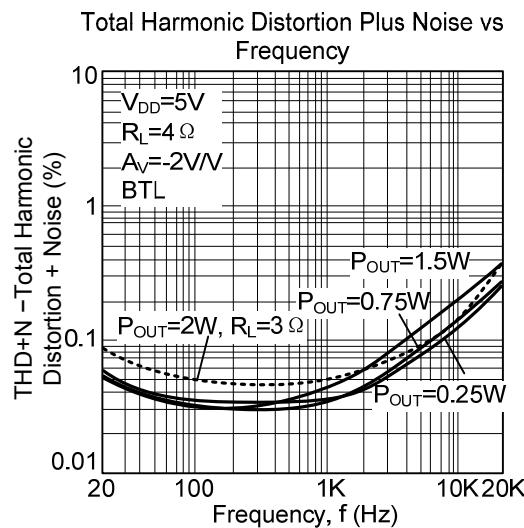


Note:1. This connection is for ultra-low current in shutdown mode.

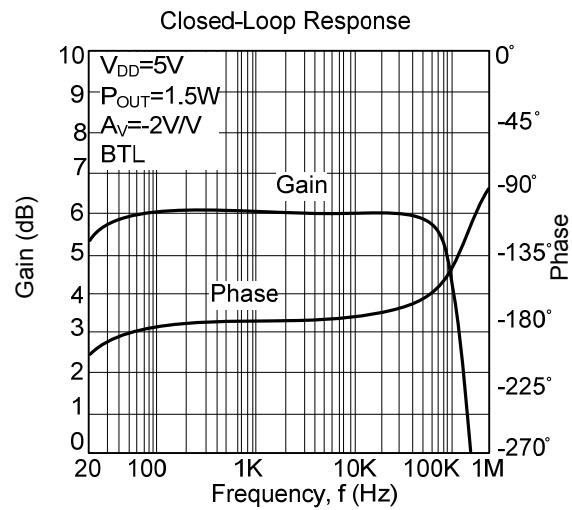
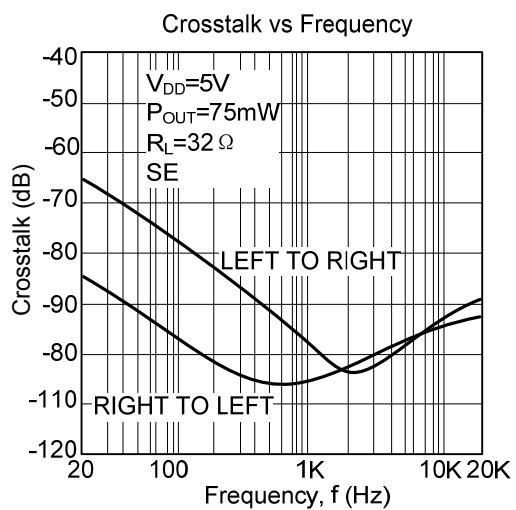
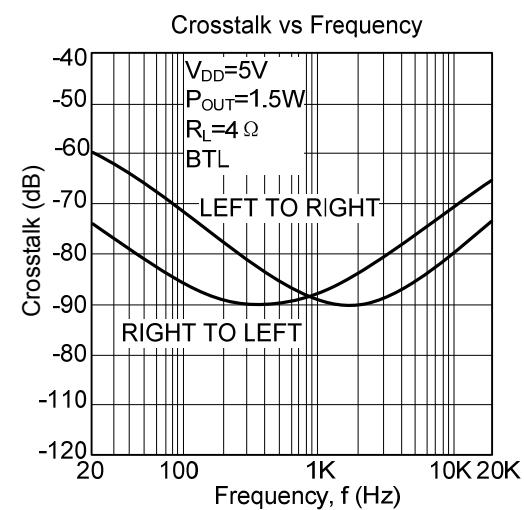
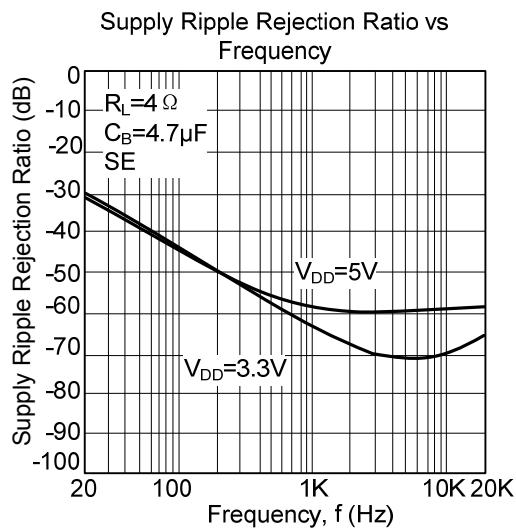
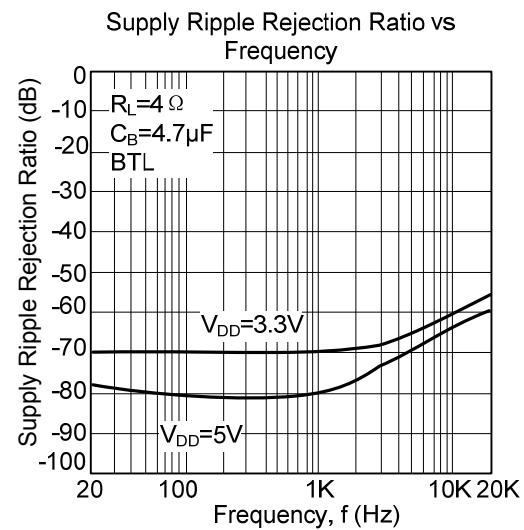
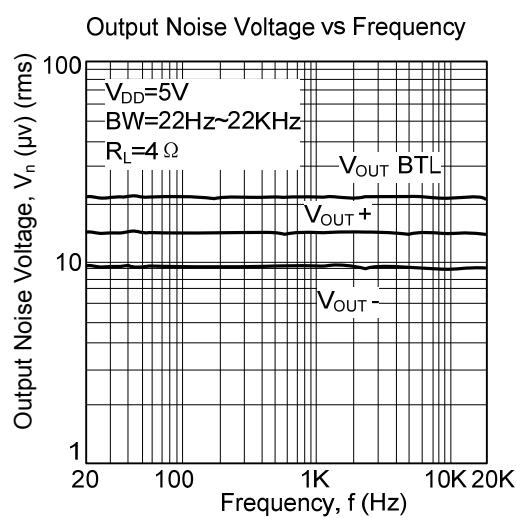
2. A 0.1 μ F ceramic capacitor should be placed as close as possible to the IC. For filtering lower-frequency noise signals, a larger aluminum electrolytic capacitor of 10 μ F or greater should be placed near the audio power amplifier.

PA3202 Full Configuration Application Circuit

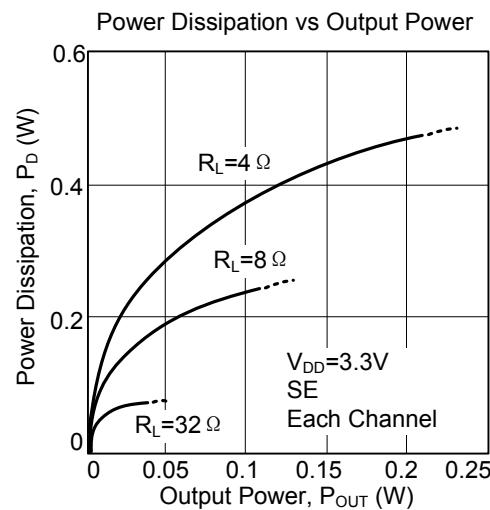
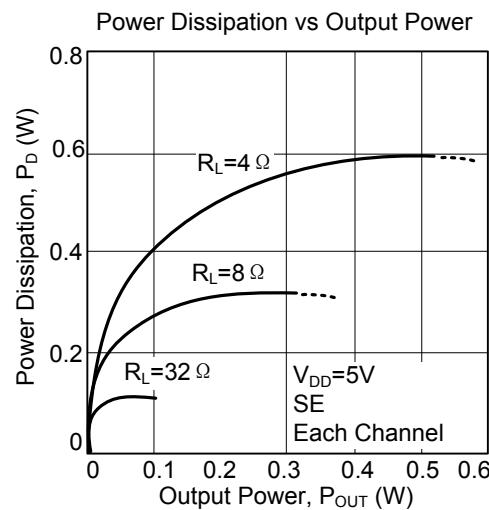
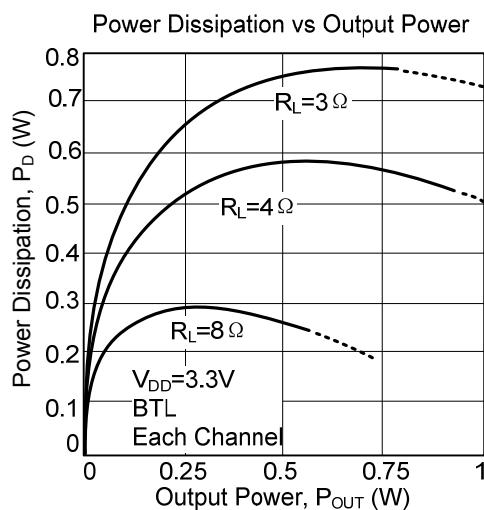
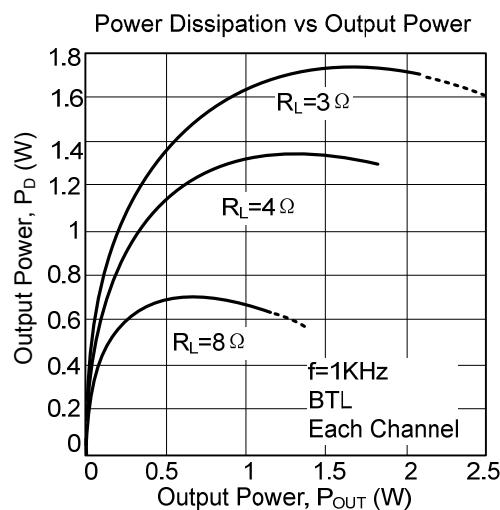
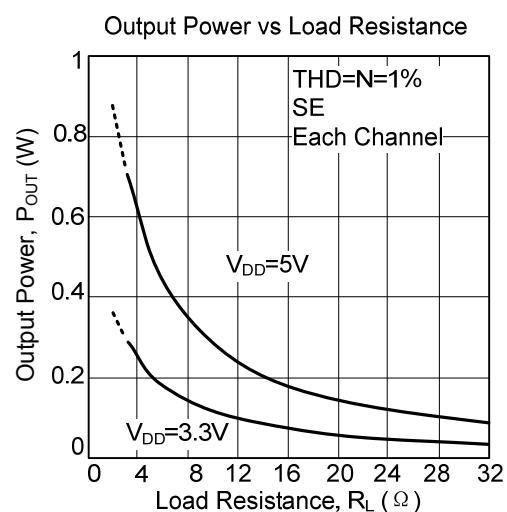
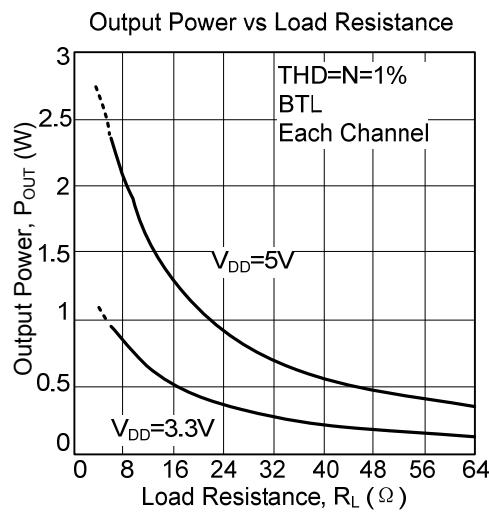
■ TYPICAL CHARACTERISTICS



■ TYPICAL CHARACTERISTICS(Cont.)



■ TYPICAL CHARACTERISTICS(Cont.)



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